

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## Features

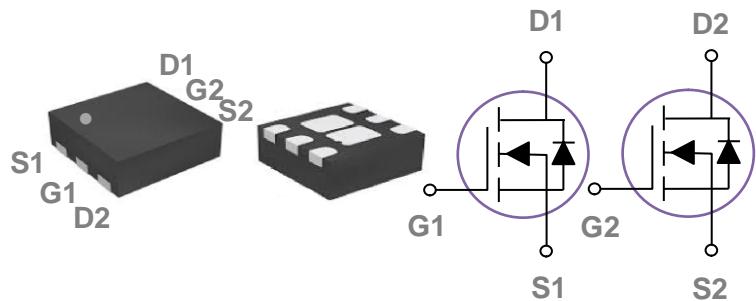
- 30V, 4.5A,  $RDS(ON) = 40m\Omega$  @  $VGS = 10V$
- Improved  $dv/dt$  capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available
- Marking : WB

## Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2<sup>nd</sup> SR

BVDSS	RDS(on)	ID
30V	40mΩ	4.5A

## DFN2X2 Dual 2EP Pin Configuration



## Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_A=25^\circ C$ )	4.5	A
	Drain Current – Continuous ( $T_A=70^\circ C$ )	3.0	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	20	A
$P_D$	Power Dissipation ( $T_A=25^\circ C$ )	1.25	W
	Power Dissipation – Derate above $25^\circ C$	0.01	W/ $^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ C$

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	100	$^\circ C/W$

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	$BV_{DSS}$ Temperature Coefficient	Reference to $25^\circ C, I_D=1mA$	---	0.02	---	$V/^\circ C$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=30V, V_{GS}=0V, T_J=25^\circ C$	---	---	1	$\mu A$
		$V_{DS}=24V, V_{GS}=0V, T_J=125^\circ C$	---	---	10	$\mu A$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	$nA$

### On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>3</sup>	$V_{GS}=10V, I_D=3A$	---	35	40	$m\Omega$
		$V_{GS}=4.5V, I_D=2A$	---	55	65	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.5	2.5	V
			---	-3.2	---	$mV/^\circ C$
$g_{fs}$	Forward Transconductance	$V_{DS}=10V, I_D=3A$	---	4	---	S

### Dynamic and switching Characteristics

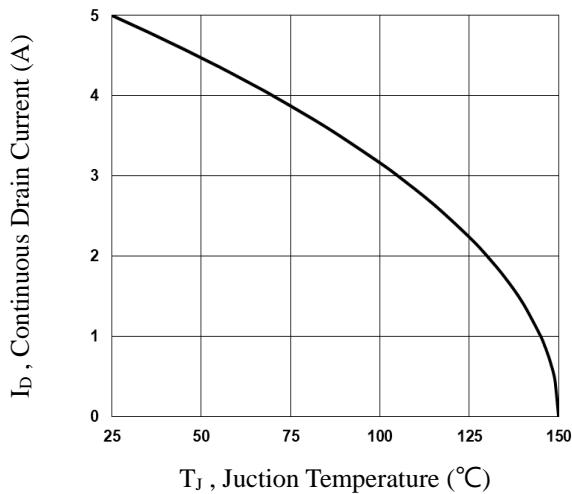
$Q_g$	Total Gate Charge <sup>2,3</sup>	$V_{DS}=24V, V_{GS}=10V, I_D=3A$	---	5.1	10	nC
$Q_{gs}$	Gate-Source Charge <sup>2,3</sup>		---	0.4	1.0	
$Q_{gd}$	Gate-Drain Charge <sup>2,3</sup>		---	2.2	4.5	
$T_{d(on)}$	Turn-On Delay Time <sup>2,3</sup>	$V_{DD}=15V, V_{GS}=10V, R_G=6\Omega$	---	2.6	5	ns
$T_r$	Rise Time <sup>2,3</sup>		---	8.8	16	
$T_{d(off)}$	Turn-Off Delay Time <sup>2,3</sup>		---	18.4	35	
$T_f$	Fall Time <sup>2,3</sup>		---	5.1	10	
$C_{iss}$	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1MHz$	---	333	660	pF
$C_{oss}$	Output Capacitance		---	52	100	
$C_{rss}$	Reverse Transfer Capacitance		---	43	85	
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1MHz$	---	0.95	2	$\Omega$

### Drain-Source Diode Characteristics and Maximum Ratings

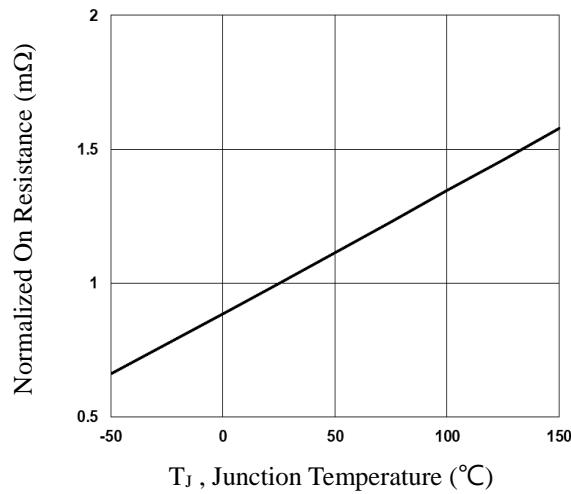
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	4.5	A
$I_{SM}$	Pulsed Source Current <sup>3</sup>		---	---	9	A
$V_{SD}$	Diode Forward Voltage <sup>3</sup>	$V_{GS}=0V, I_s=1A, T_J=25^\circ C$	---	---	1	V

Note :

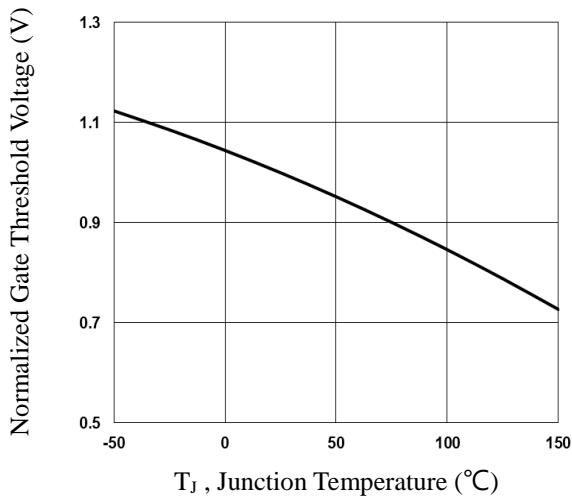
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
3. Essentially independent of operating temperature.



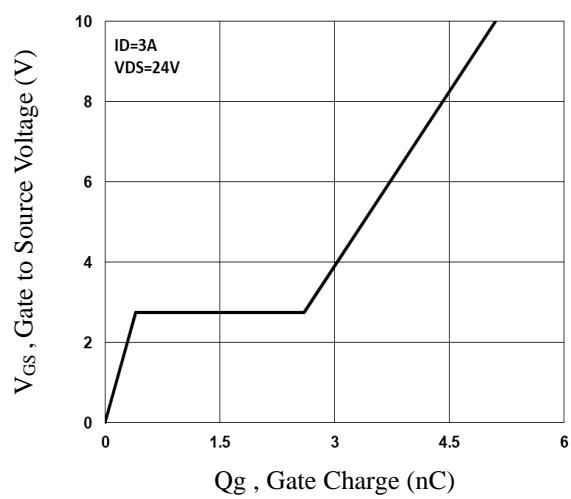
**Fig.1 Continuous Drain Current vs. T<sub>J</sub>**



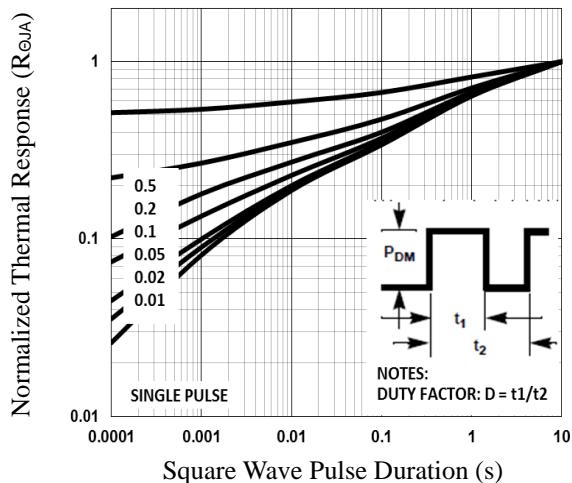
**Fig.2 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>**



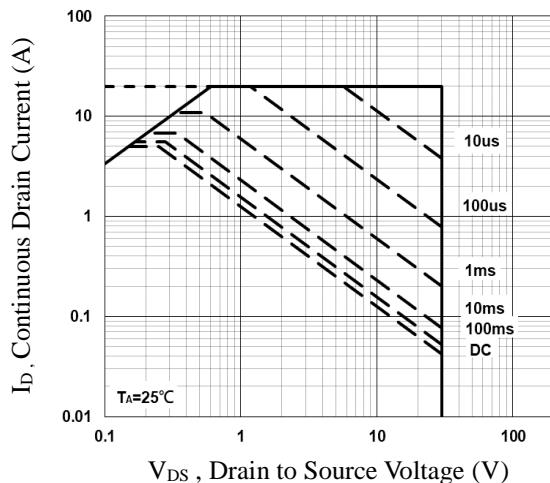
**Fig.3 Normalized V<sub>th</sub> vs. T<sub>J</sub>**



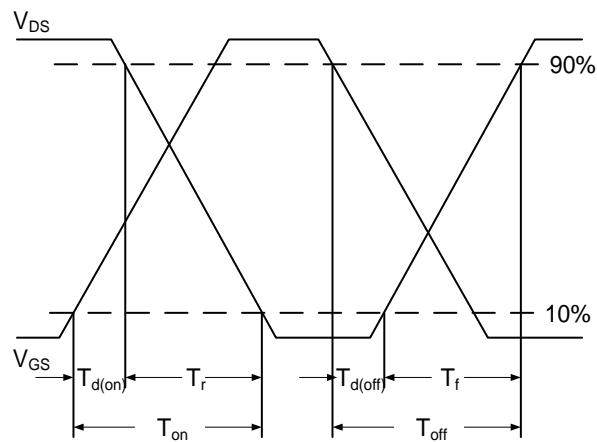
**Fig.4 Gate Charge Waveform**



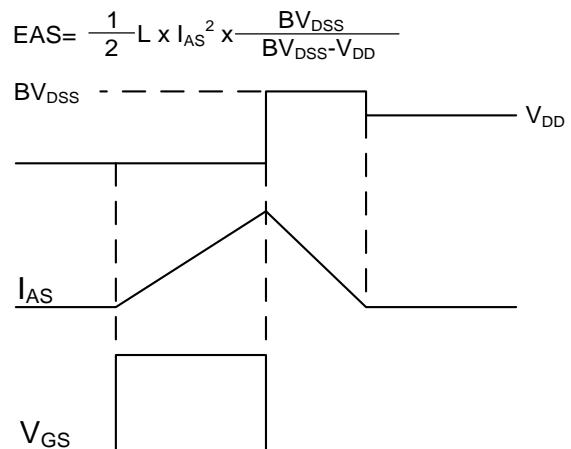
**Fig.5 Normalized Transient Response**



**Fig.6 Maximum Safe Operation Area**

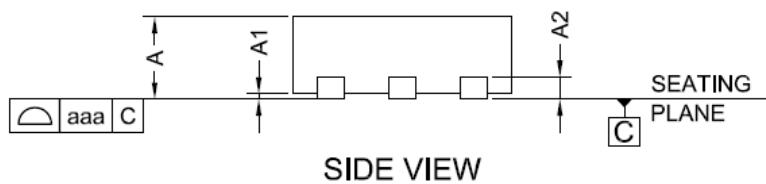
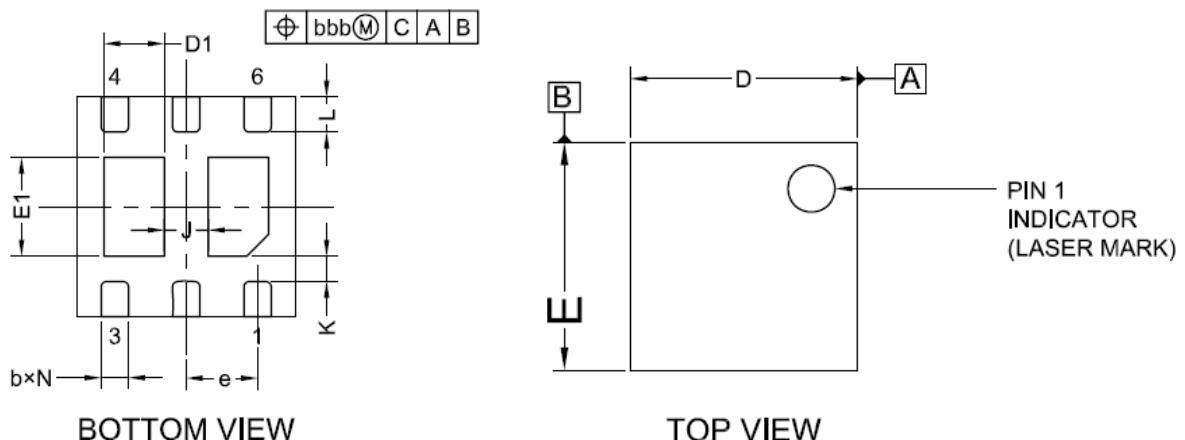


**Fig.7 Switching Time Waveform**



**Fig.8 EAS Waveform**

## DFN2X2 Dual 2EP PACKAGE INFORMATION



COMMON DIMENSIONS  
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2		0.203	
b	0.20	0.25	0.30
D	1.95	2.00	2.05
D1	0.50	0.55	0.60
E	1.95	2.00	2.05
E1	0.85	0.90	0.95
e		0.65BSC	
L	0.27	0.32	0.37
J		0.40BSC	
K		0.20MIN	
N		6	
aaa		0.08	
bbb		0.10	

单击下面可查看定价，库存，交付和生命周期等信息

[>>SHIKUES\(时科\)](#)